CORRECTION



## Correction to: Generation and Demolishment Mechanisms of Vapor Bubble Around Hot Tungsten Filament in Superfluid Helium-4

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Published online: 15 February 2022 © The Author(s) 2022

## Correction to: Journal of Low Temperature Physics (2021) 202:418–430 https://doi.org/10.1007/s10909-020-02546-8

The article "Generation and Demolishment Mechanisms of Vapor Bubble Around Hot Tungsten Filament in Superfluid Helium-4", written by Che-Chi Shih, Ming-Huei Huang, Pang-Chia Chang, Po-Wei Yu, Wen-Bin Jian, Kimitoshi Kono, was originally published electronically on the publisher's internet portal on 7 January 2021 without open access. With the author(s)' decision to opt for Open Choice the copyright of the article changed on 7 January 2022 to © The Author(s) 2021 and the article is forthwith distributed under a Creative Commons Attribution 4.0 International License, which permits use, sharing, adaptation, distribution and reproduction in any medium or format, as long as you give appropriate credit to the original author(s) and the source, provide a link to the Creative Commons licence, and indicate if changes were made. The images or other third party material in this article are included in the article's Creative Commons licence, unless indicated otherwise in a credit line to the material. If material is not included in the article's Creative Commons licence and your intended use is not permitted by statutory regulation or exceeds the permitted use, you will need to obtain permission directly from the

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The original article can be found online at https://doi.org/10.1007/s10909-020-02546-8.

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